



#### P-CHANNEL ENHANCEMENT MODE MOSFET

#### **Features**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- **ESD Protected**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP2035UQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

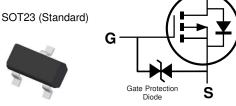
https://www.diodes.com/guality/product-definitions/

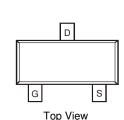
### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram Below
- Weight: 0.009 grams (Approximate)









Top View

Internal Schematic

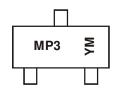
Ordering Information (Notes 4 & 5)

Part Number	Compliance	Case	Packaging
DMP2035U-7	Standard	SOT23 (Standard)	3,000 / 7" Tape & Reel
DMP2035UQ-7	Automotive	SOT23 (Standard)	3,000 / 7" Tape & Reel
DMP2035U-13	Standard	SOT23 (Standard)	10,000 / 13" Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.
- 5. The ESD gate protection diode is only designed to protect against ESD events. No gate-source voltage greater than the maximum V<sub>GSS</sub> rating (given on page 2) can be applied.

### **Marking Information**



MP3 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Year	2011		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	Υ		I	J	K	L	М	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Month Code	Jan 1	Feb 2	Mar 3	Apr 4	<b>May</b> 5	Jun 6	Jul 7	Aug 8	<b>Sep</b> 9	Oct O	<b>Nov</b> N	<b>Dec</b>



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	-20	V	
Gate-Source Voltage			Vgss	±10	٧
Continuous Drain Current (Note 8) V <sub>GS</sub> = -4.5V	l <sub>D</sub>	-4.9 -4.0	А		
Pulsed Drain Current (Note 8)		I <sub>DM</sub>	-24	Α	
Maximum Continuous Body Diode Forward Curren	it (Note 7)	Is	-1.2	Α	
Pulsed Body Diode Forward Current (Note 10)			lsм	-24	Α

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	PD	0.81	W
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>0JA</sub>	153.5	°C/W
Total Power Dissipation (Note 7)	PD	1.2	W
Thermal Resistance, Junction to Ambient (Note 7)	R <sub>0JA</sub>	100	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	V	V <sub>G</sub> S = 0V, I <sub>D</sub> = -250µA	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	_	-1.0	μA	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.4	-0.7	-1.0	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$	
			23 30 41	35 45 62	mΩ	$V_{GS} = -4.5V$ , $I_D = -4.0A$	
Static Drain-Source On-Resistance	RDS(ON)	_				$V_{GS} = -2.5V, I_{D} = -4.0A$	
						V <sub>G</sub> S = -1.8V, I <sub>D</sub> = -2.0A	
Forward Transfer Admittance	Y <sub>FS</sub>	_	14	_	s	$V_{DS} = -5V, I_{D} = -4A$	
Diode Forward Voltage	V <sub>SD</sub>	_	-0.7	-1.0	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = -1A	
DYNAMIC CHARACTERISTICS (Note 10)	•	•	•	•	•		
Input Capacitance	Ciss	_	1,610	_	pF	J., ,,,,,	
Output Capacitance	Coss	_	157	_	pF	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V - f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	145	_	рF	1 – 1.000112	
Gate Resistance	Rg	_	9.45	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	15.4	_	nC	45), 45),	
Gate-Source Charge	Qgs	_	2.5	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$	
Gate-Drain Charge	Q <sub>gd</sub>	_	3.3	_	nC	- I <sub>D</sub> = -4A	
Turn-On Delay Time	tD(ON)	_	16.8	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	12.4	_	ns	V <sub>DS</sub> = -10V, V <sub>GS</sub> = -4.5V,	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	94.1	_	ns	$R_L=10\Omega,R_g=6.0\Omega,I_D=-1A$	
Turn-Off Fall Time	t <sub>F</sub>	_	42.4	_	ns	7	

Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

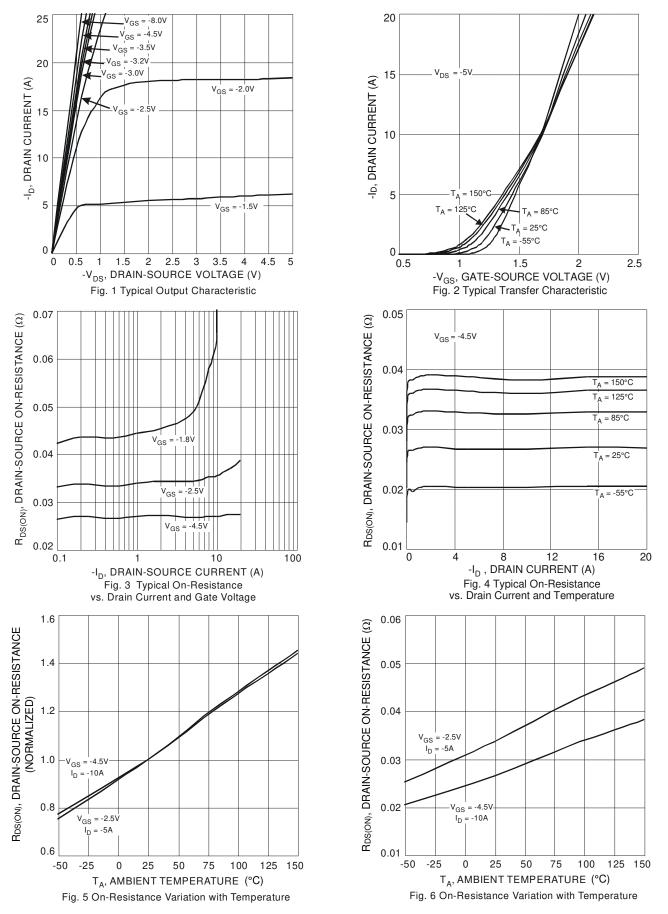
  7. Device mounted on FR-4 substrate PC board, 2oz copper, with 25mm X 25mm square copper plate.

  8. Repetitive rating, pulse width limited by junction temperature.

  9. Short duration pulse test used to minimize self-heating effect.

  10. Guaranteed by design. Not subject to product testing.







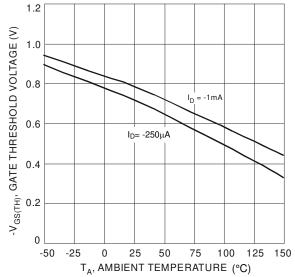
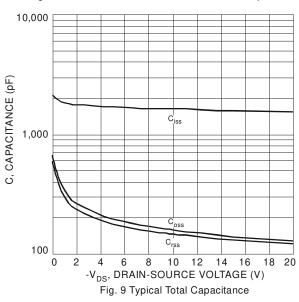
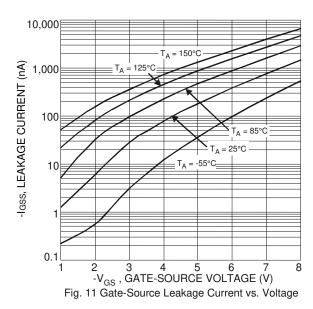
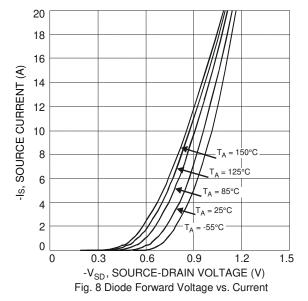
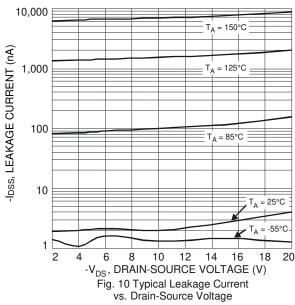


Fig. 7 Gate Threshold Variation vs. Ambient Temperature









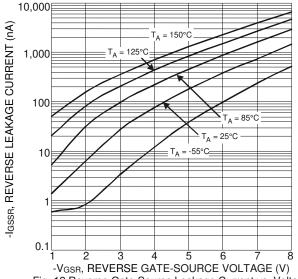
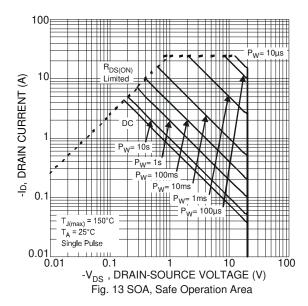


Fig. 12 Reverse Gate-Source Leakage Current vs. Voltage





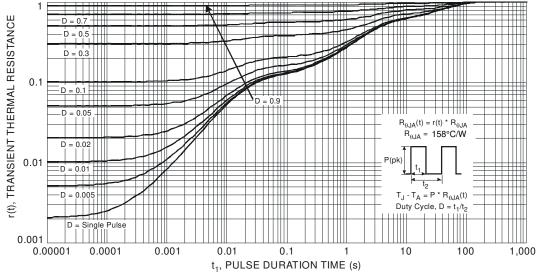


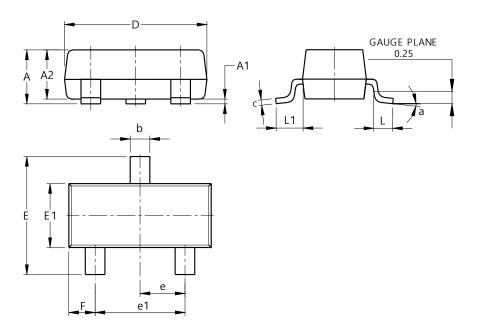
Fig. 14 Transient Thermal Response



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23 (Standard)

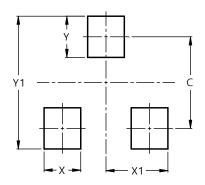


SOT23 (Standard)							
Dim	Min	Max	Тур				
Α	0.90	1.15	1.025				
<b>A</b> 1	0.00	0.10	0.05				
A2	0.85	1.10	0.975				
b	0.30	0.51	0.40				
С	0.080	0.202	0.11				
D	2.80	3.00	2.90				
Е	2.25	2.55	2.40				
E1	1.20	1.40	1.30				
е	0.89	1.03	0.915				
e1	1.78	2.05	1.83				
F	0.40	0.60	0.535				
L1	0.45	0.61	0.55				
L	0.25	0.55	0.40				
а	0°	8°					
All Dimensions in mm							

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT23 (Standard)



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Υ	0.9
V1	29



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